

# G-Premio BOND TECHNIQUE GUIDE

**GC**



Prior to use, carefully read the instructions for use.



Consult  
Instructions  
for Use

## SELECT ETCHING MODE



Etch for 10-15 sec.,  
rinse for 5 sec. and dry.

## BONDING PROCEDURE



Apply G-Premio  
BOND and wait  
10 sec.



Start placing  
composite.



Dry.



Light cure.

## Light curing time

Light curing unit	Distance from light guide tip	
	<10mm	>10mm
Halogen / LED (700 mW/cm <sup>2</sup> )	10 sec.	20 sec.
High power LED (>1200 mW/cm <sup>2</sup> )	5 sec.	10 sec.

## INTRAORAL REPAIR



Roughen surface.  
Rinse and dry.



Apply Ceramic  
Primer II on ceramic  
surfaces. Dry.



Apply G-Premio  
BOND to all  
surfaces and wait  
10 sec.



Dry.



Light cure.

## HYPERSENSITIVITY TREATMENT



Apply G-Premio  
BOND. Wait 10 sec.



Dry.



Light cure.



Remove  
unpolymerized layer.